



N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

V _{(BR)DSS}	R _{DS(ON)} max	l _D max T _A = +25°C		
30V	14mΩ @ V _{GS} = 10V	8.6A		
300	20mΩ @ V _{GS} = 4.5V	7.1A		

Description

This MOSFET has been designed to minimize the on-state resistance (R_{DS(ON)}) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Applications

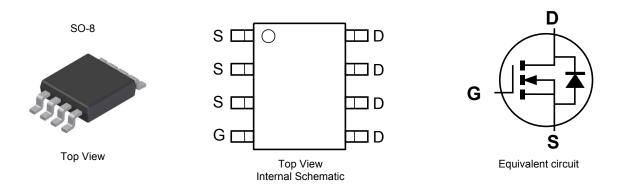
- Backlighting
- **Power Management Functions**
- DC-D C Converters

Features

- w On-Resistance Lo
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: SO-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals Connections: See Diagram
- Terminals: Finish Matte Tin annealed over Copper lead frame. Solderable per MIL-STD-202, Method 208 3
- Weight: 0.072g (approximate)



Ordering Information (Note 4)

Part Number	Case	Packaging
DMN4800LSS-13	SO-8	2500/Tape & Reel

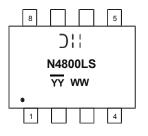
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green"

Notes:

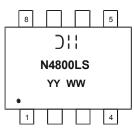
and Lead-free 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



Chengdu A/T Site



Shanghai A/T Site

) | | = Manufacturer's Marking N4800LS = Product Type Marking Code YYWW = Date Code Marking YY or \overline{YY} = Year (ex: 13 = 2013) WW = Week (01 - 53) YY = Date Code Marking for SAT (Shanghai Assembly/ Test site) YY = Date Code Marking for CAT (Chengdu Assembly/ Test site)



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic S	ymbol	Value	Units		
Drain-Source Voltage	V _{DSS}	30	V		
Gate-Source Voltage	V _{GSS}	±25	V		
Continuous Drain Current (Note 6) V _{GS} = 10V	Steady State	T _A = +25°C T _A = +70°C	ID	8.6 6.3	А
	t<10s	T _A = +25°C T _A = +70°C	ID	11.8 9.0	A
Maximum Body Diode Forward Current (Note 6)	Is	2.4 A			
Pulsed Drain Current (Note 7)			I _{DM}	50 A	

Thermal Characteristics

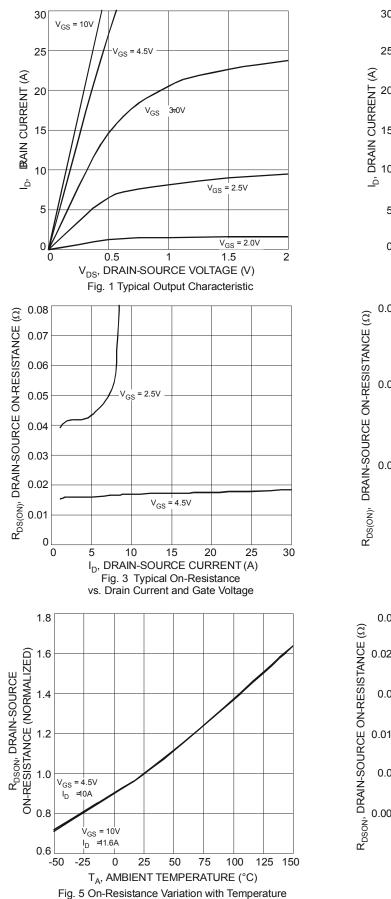
Characteristic S	ymbol	Value	Units		
Total Dower Dissinction (Note 5)	T _A = +25°C		1.46	W	
Total Power Dissipation (Note 5)	T _A = +70°C	P _D	0.9	vv	
Thermal Resistance, Junction to Ambient (Note 5)	Steady state	D	86	°C/W	
	t<10s	R _{0JA}	46	C/W	
Tatal Davies Disainstics (Nata 0)	T _A = +25°C		1.7	W	
Total Power Dissipation (Note 6)	T _A = +70°C	PD PD	1.0	vv	
Thermal Desistance Junction to Ambient (Note 6)	Steady state	5	75		
Thermal Resistance, Junction to Ambient (Note 6)	t<10s	R _θ JA	40	°C/W	
Thermal Resistance, Junction to Case (Note 6)		$R_{ ext{ heta}JC}$	15		
Operating and Storage Temperature Range		T _{J.} T _{STG}	-55 to +150	°C	

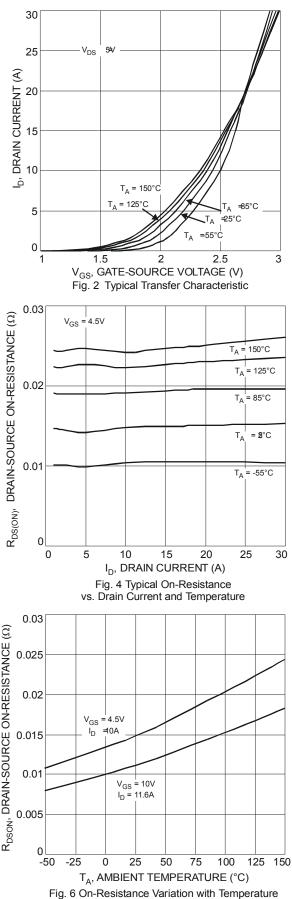
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic S	ymbol	Min	Тур	Мах	Unit	Test Condition	
OFF CHARACTERISTICS (Note 8)	je .				•		
Drain-Source Breakdown Voltage	BV _{DSS}	30	_		V	V _{GS} = 0V, I _D = 250µA	
Zero Gate Voltage Drain Current	I _{DSS}	_	_	1	μA	V _{DS} = 30V, V _{GS} = 0V	
Gate-Source Leakage	Igss	—	_	±100	nA	V _{GS} = ±20V, V _{DS} = 0V	
ON CHARACTERISTICS (Note 8)							
Gate Threshold Voltage	V _{GS(th)}	0.8 1.	2	1.6	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$	
Static Drain-Source On-Resistance	Pag (au)		11	14 mΩ	V _{GS} = 10V, I _D = 9A		
	R _{DS (ON)}		14	20	11122	V _{GS} = 4.5V, I _D = 7A	
Forward Transconductance	g fs	—	8		S	V _{DS} = 10V, I _D = 9A	
Diode Forward Voltage (Note 8)	V _{SD}	—	0.72 0.9).72 0.94 V		$V_{GS} = 0V, I_{S} = 1A$	
DYNAMIC CHARACTERISTICS (Note 9)							
Input Capacitance	C _{iss}	—	798		pF		
Output Capacitance	C _{oss}	—	128		pF	V _{DS} = 10V, V _{GS} = 0V - f = 1.0MHz	
Reverse Transfer Capacitance	C _{rss}	_	122		pF		
Gate Resistance	R _G	_	1.37		Ω	V _{DS} = 0V, V _{GS} = 0V, f = 1.0MHz	
Total Gate Charge	Qg	_	8.7				
Gate-Source Charge	Q _{gs}	_	1.7	_	nC	V _{GS} = 5V, V _{DS} = 15V, I _D = 9A	
Gate-Drain Charge	Q _{qd}	_	2.4	_			
Turn-On Delay Time	t _{d(on)}	_	5.03	_		V _{DD} = 15V, V _{GEN} = 10V,	
Rise Time	tr	_	4.50	_			
Turn-Off Delay Time	t _{d(off)}	_	26.33	_	ns	$R_L = 15\Omega, R_G = 6.0\Omega, I_D = 1A$	
Fall Time	t _f	_	8.55				

 Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper pad layout
Repetitive rating, pulse width limited by junction temperature.
Short duration pulse test used to minimize self-heating effect.
Guaranteed by design. Not subject to product testing. Notes:









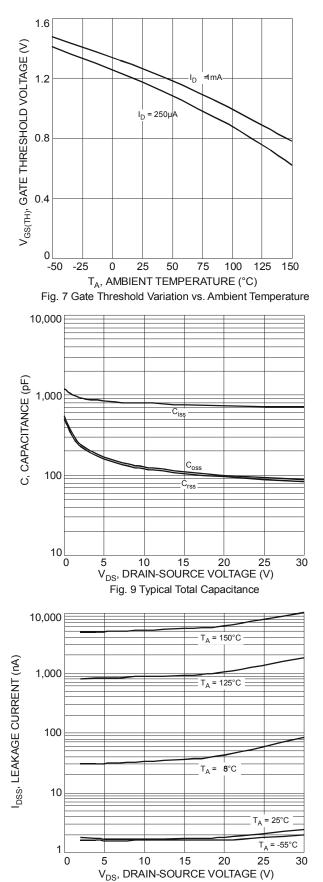
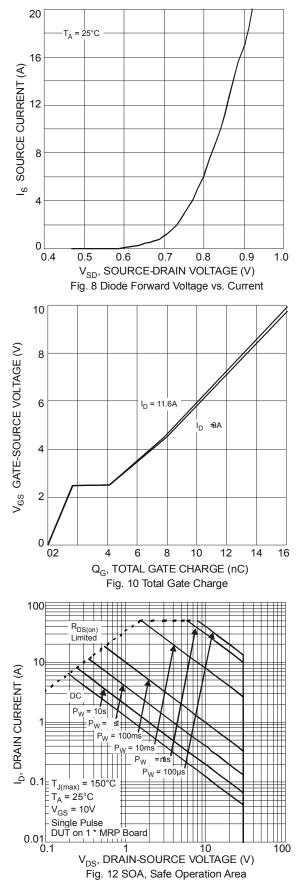
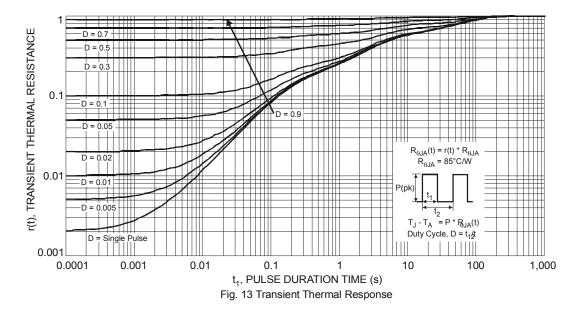


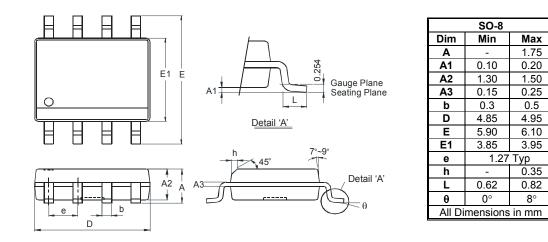
Fig. 11 Typical Leakage Current vs. Drain-Source Voltage



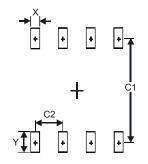




Package Outline Dimensions



Suggested Pad Layout



Dimensions	Value (in mm)
Х	0.60
Y	1.55
C1	5.4
C2	1.27



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